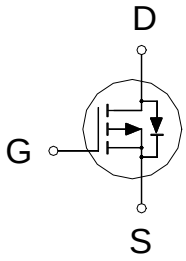
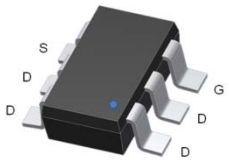
P-Channel Logic Level Enhancement Mode Field Effect Transistor

Product Summary:

BV_{DSS}	-20V
$R_{DSON\ (MAX.)}$	60mΩ
I_D	-4.5A





Pb-Free Lead Plating & Halogen Free

GP
GREEN PRODUCT

ABSOLUTE MAXIMUM RATINGS (T_A = 25 °C Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS		SYMBOL	LIMITS	UNIT
Gate-Source Voltage		V_{GS}	±12	V
Continuous Drain Current	T_A = 25 °C	I_D	-4.5	A
	T_A = 70 °C		-3.2	
Pulsed Drain Current[1]		I_{DM}	-18	
Power Dissipation	T_A = 25 °C	P_D	1.25	W
	T_A = 70 °C		0.8	
Operating Junction & Storage Temperature Range		T_j, T_{stg}	-55 to 150	°C

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNIT
Junction-to-Ambient	$R_{\theta JA}$		100	°C / W

[1]Pulse width limited by maximum junction temperature.

[2]Duty cycle ≤ 1%

ELECTRICAL CHARACTERISTICS (T_A = 25 °C, Unless Otherwise Noted)

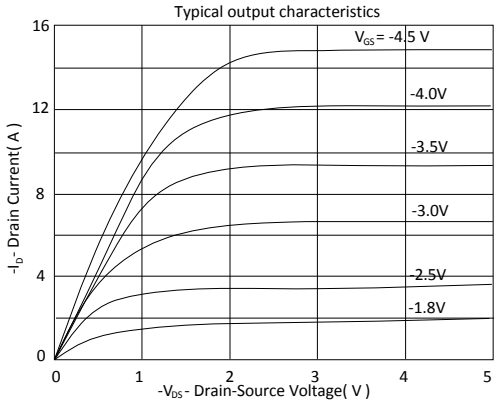
PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
STATIC						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	V_{GS} = 0V, I_D = -250μA	-20			V
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = -250μA	-0.3	-0.75	-1.2	
Gate-Body Leakage	I_{GSS}	V_{DS} = 0V, V_{GS} = ±12V			±100	nA
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS} = -16V, V_{GS} = 0V			-1	μA
		V_{DS} = -16V, V_{GS} = 0V, T_J = 125 °C			-10	
On-State Drain Current[1]	$I_{D(ON)}$	V_{DS} = -5V, V_{GS} = -4.5V	-4.5			A
Drain-Source On-State Resistance[1]	$R_{DS(ON)}$	V_{GS} = -4.5V, I_D = -3.5A		50	60	mΩ
		V_{GS} = -2.5V, I_D = -2.5A		75	96	
		V_{GS} = -1.8V, I_D = -1.0A		150	250	
Forward Transconductance[1]	g_{fs}	V_{DS} = -5V, I_D = -3.5A		10		S
DYNAMIC						
Input Capacitance	C_{iss}	V_{GS} = 0V, V_{DS} = -10V, f = 1MHz		382		pF
Output Capacitance	C_{oss}			70		
Reverse Transfer Capacitance	C_{rss}			60		
Total Gate Charge[1,2]	Q_g	V_{DS} = -10V, V_{GS} = -4.5V, I_D = -3.5A		7.2		nC
Gate-Source Charge[1,2]	Q_{gs}			1.2		
Gate-Drain Charge[1,2]	Q_{gd}			2.3		
Turn-On Delay Time[1,2]	$t_{d(on)}$	V_{DS} = -10V, I_D = -1A, V_{GS} = -4.5V, R_{GS} = 6Ω		17		nS
Rise Time[1,2]	t_r			32		
Turn-Off Delay Time[1,2]	$t_{d(off)}$			37		
Fall Time[1,2]	t_f			32		
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (T_C = 25 °C)						
Continuous Current	I_S				-4.5	A
Pulsed Current[3]	I_{SM}				-18	
Forward Voltage[1]	V_{SD}	I_F = I_S, V_{GS} = 0V			-1.2	V

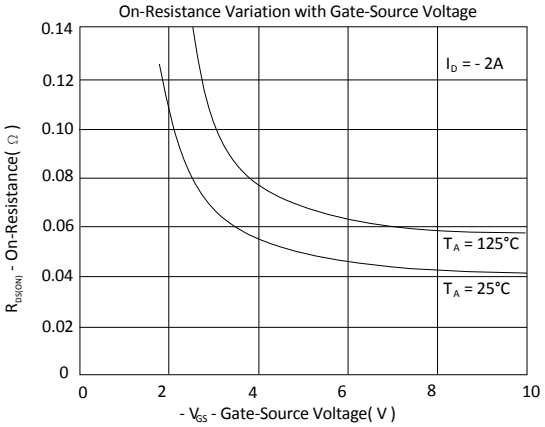
[1]Pulse test : Pulse Width ≤ 300 μsec, Duty Cycle ≤ 2%.

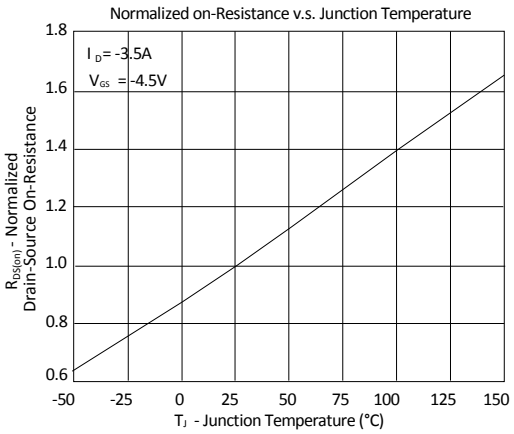
[2]Independent of operating temperature.

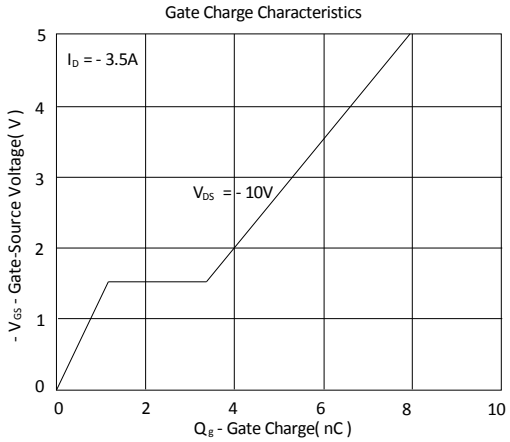
[3]Pulse width limited by maximum junction temperature.

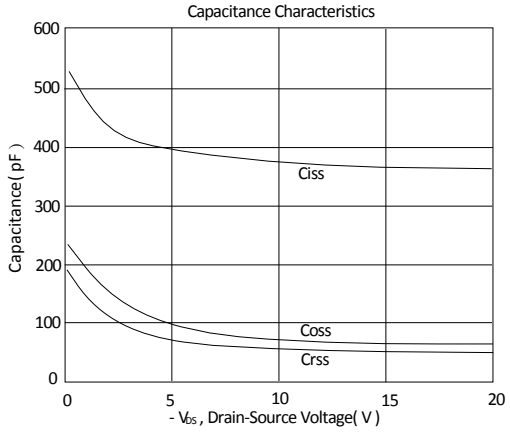
TYPICAL CHARACTERISTICS

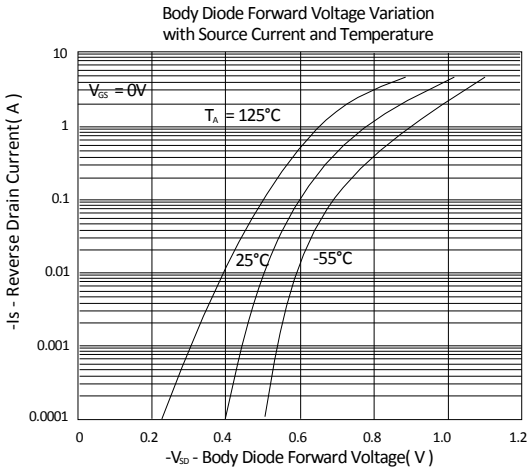




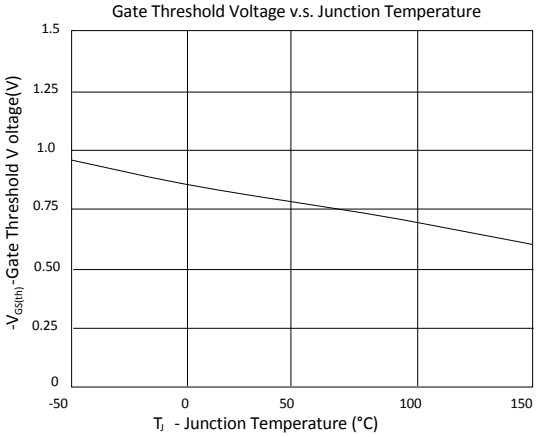




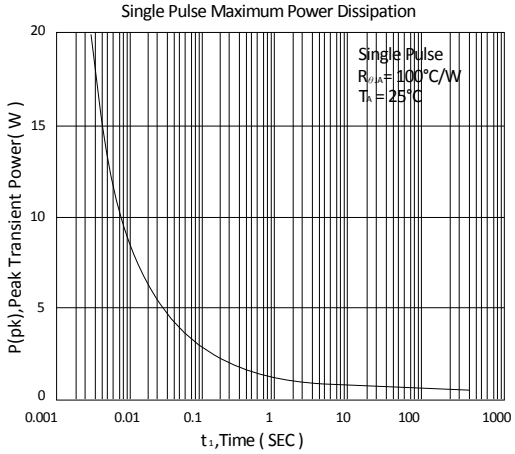




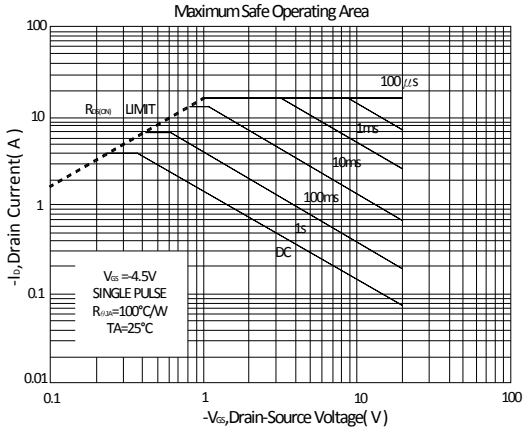
Gate Threshold Voltage v.s. Junction Temperature



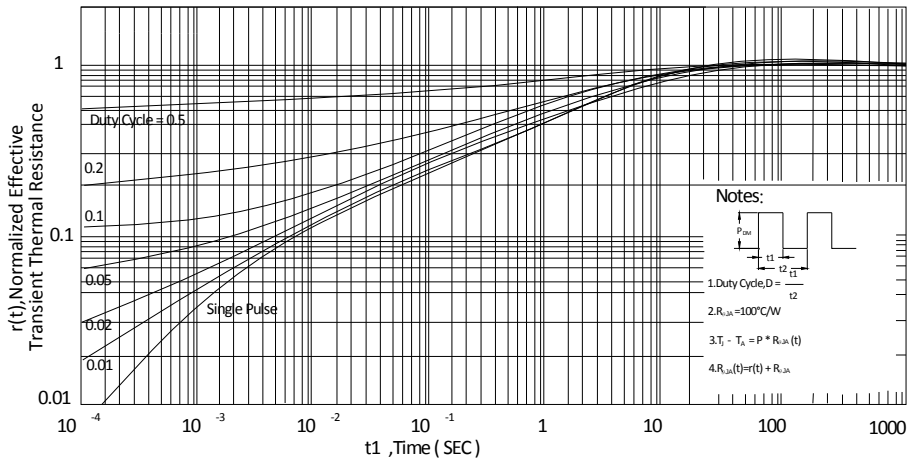
Single Pulse Maximum Power Dissipation



Maximum Safe Operating Area

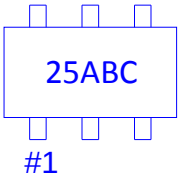


Transient Thermal Response Curve



Ordering & Marking Information:

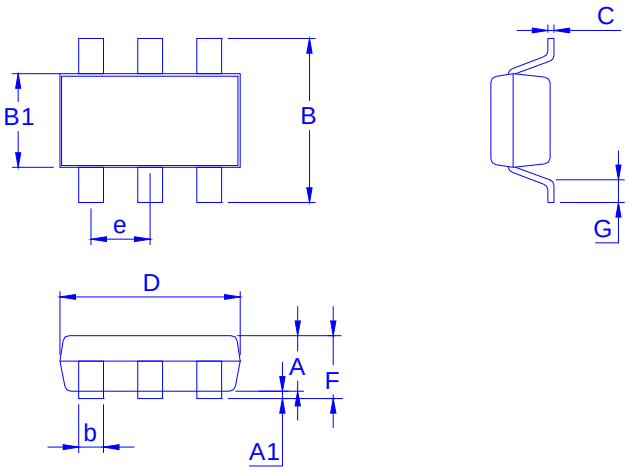
Device Name: LB60P02K for TSOP-6



25: Device Code, 25 for LB60P02K

ABC: Date Code

Outline Drawing



Dimension in mm

Dimension	A	A1	B	B1	b	C	D	e	F	G
Min.	0.70	0	2.50	1.50	0.30	0.08	2.70		0.75	0.30
Typ.			2.80	1.60	0.40		2.90	0.95		
Max.	1.00	0.10	3.10	1.70	0.50	0.20	3.10		1.10	0.60

Footprint